

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization
International Bureau



(43) International Publication Date
22 February 2001 (22.02.2001)

PCT

(10) International Publication Number
WO 01/12690 A1

- (51) International Patent Classification⁷: C08F 292/00,
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- (22) International Filing Date: 27 July 2000 (27.07.2000)
- (25) Filing Language: English (81) Designated States (national): AE, AG, AL, AM, AT, AU,
AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CR, CU, CZ,
DE, DK, DM, DZ, EE, ES, FI, GB, GD, GE, GH, GM, HR,
HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR,
LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ,
NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TI, TM,
TR, TT, TZ, UA, UG, US, UZ, VN, YU, ZA, ZW.
- (26) Publication Language: English
- (30) Priority Data:
11/2282296 12 August 1999 (12.08.1999) JP (84) Designated States (regional): ARIPO patent (GH, GM,
KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZW), Eurasian
patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European
patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE,
IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG,
CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).
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Published:

— With international search report.

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

WO 01/12690 A1

(54) Title: RESIN COMPOSITION COMPRISING PARTICLES

(57) Abstract: A resin composition comprising: A) particles prepared by bonding at least one oxide of an element selected from the group consisting of silicon, aluminum, zirconium, titanium, zinc, germanium, indium, tin, antimony, and cerium, and an organic compound which includes a polymerizable unsaturated group, B) an oligomer-type radiation polymerization initiator having a site which generates photo-radicals by irradiation of radioactive rays, and C) a compound having at least two polymerizable unsaturated groups in the molecule.

RESIN COMPOSITION COMPRISING PARTICLES

5 The present invention relates to a resin composition comprising particles and a cured product made from the composition.

Prior Art

10 In recent years, a resin composition exhibiting excellent coatability and capable of forming coatings with high hardness, superior scratch resistance, low curling properties, superb adhesion, and excellent transparency and appearance is desired as
15 a protective coating material to prevent stains or scratches on the surface of various substrates, an adhesive for various substrates, a sealing material, or a vehicle for printing ink. Various materials comprising colloidal silica have been proposed with an
20 objective to improve scratch resistance among these required characteristics. For example, USP 3,451,838 and USP 2,404,357 disclose compositions comprising a hydrolyzate of alkoxy silane and colloidal silica as major components to be used as a heat-curable coating
25 material. Japanese Patent Publication No. 21815/1987 discloses a composition for a photocurable coating material comprising an acrylate and particles of colloidal silica of which the surface is modified by methacryloxy silane. A feature of these coating
30 materials is to improve performance of the coating materials by treating the surface of silica particles with a specific organic silane or under specific conditions. However, these coating materials do not necessarily satisfy satisfactorily all of the
35 requirements such as coatability, high hardness,

superior scratch resistance, low curling properties, and superb adhesion, when made into coatings. Specifically, to increase hardness of the coatings, a crosslinking density of the coatings must be increased 5 after cure. However, an increase in the hardness accompanies cure shrinkage of the coatings, which produced a large curl. To have well balanced hardness and low curl properties is thus difficult.

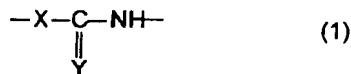
10 Problems to be solved by the Invention

The present invention has been completed in view of the above-described problems and has an object of providing a resin composition exhibiting excellent coatability and capable of forming coatings with high 15 hardness, superior scratch resistance, low curling properties, and superb adhesion, particularly well balanced high hardness and low curling properties, on the surface of various substrates, such as, for example, plastics (polycarbonate, 20 polymethylmethacrylate, polystyrene, polyester, polyolefin, epoxy resins, melamine resins, triacetyl cellulose resins, ABS resins, AS resins, norbornene resins, etc.), metals, woods, papers, glasses, and slates, as well as the cured products made from the 25 resin composition. The resin composition and the cured product are suitable for use, for example, as a protective coating material to prevent stains or scratches on plastic optical parts, touch panels, film-type liquid crystal elements, plastic containers, or 30 flooring materials, wall materials, and artificial marbles which are used for architectural interior finish; as an adhesive for various substrates, a

sealing material, and a vehicle for printing ink; and the like.

Means for Solving the Problems

- 5 As a result of extensive studies, the present inventors have found that the products with well balanced high hardness and low curling properties can be achieved by a resin composition comprising: (A) particles produced by bonding oxide particles of
10 specific element and an organic compound containing a polymerizable unsaturated group (preferably the specific organic compound of formula (1))



- 15 wherein X represents NH, O (oxygen atom), or S (sulfur atom), and Y represents O or S, (B) a specific oligomer-type radiation polymerization initiator, and (C) a compound having at least two polymerizable
20 unsaturated groups in the molecule; and cured products of the resin composition.

Preferred Embodiment of the Invention

- The resin composition and the cured
25 products thereof of the present invention will now be described in more detail.

I. Resin Composition

- The resin composition of the present invention comprises (A) particles produced by bonding
30 oxide particles of specific element and an organic compound containing a polymerizable unsaturated group (preferably the specific organic compound of the above

formula (1)) (such particles may be called "crosslinkable particles (A)"), (B) an oligomer-type radiation polymerization initiator having a site which produces photo-radicals by radiation (hereinafter may 5 be called "oligomer-type radiation polymerization initiator"), and (C) a compound having at least two polymerizable unsaturated groups in the molecule (hereinafter may be called "compound (C)").

10 Each component for the resin composition of the present invention will be described in more detail.

1. Crosslinkable particles (A)

The crosslinkable particles (A) used in the present invention are the particles produced by bonding particles of at least one oxide of an element selected 15 from the group consisting of silicon, aluminum, zirconium, titanium, zinc, germanium, indium, tin, antimony, and cerium, and an organic compound containing a polymerizable unsaturated group (preferably an organic compound containing the group 20 shown by the above formula (1)).

(1) Oxide particles

For obtaining uncolored cured coatings from the resin composition, the oxide particles used in the present invention should be particles of at least one 25 oxide of an element selected from the group consisting of silicon, aluminum, zirconium, titanium, zinc, germanium, indium, tin, antimony, and cerium.

As these oxides, for example, silica, alumina, zirconia, titania, zinc oxide, germanium 30 oxide, indium oxide, tin oxide, indium-tin oxide (ITO), antimony oxide, and cerium oxide can be given. Of these, silica, alumina, zirconia, and antimony oxide are preferable from the viewpoint of high hardness.

These compounds may be used either individually or in combination of two or more. In addition, oxide particles of these elements are preferably in the form of a powder or a solvent dispersion sol. When the 5 oxide particles are in the form of dispersion, an organic solvent is preferable as a dispersion medium from the viewpoint of mutual solubility with other components and dispersibility. As examples of such organic solvents, alcohols such as methanol, ethanol, 10 isopropanol, butanol, and octanol; ketones such as acetone, methyl ethyl ketone, methyl isobutyl ketone, and cyclohexanone; esters such as ethyl acetate, butyl acetate, ethyl lactate, and γ -butyrolactone; ethers such as ethylene glycol monomethyl ether and diethylene 15 glycol monobutyl ether; aromatic hydrocarbons such as benzene, toluene, and xylene; and amides such as dimethylformamide, dimethylacetamide, and N-methylpyrrolidone can be given. Of these, methanol, isopropanol, butanol, methyl ethyl ketone, methyl 20 isobutyl ketone, ethyl acetate, butyl acetate, toluene, and xylene are preferable.

The number average particle diameter of the oxide particles is from 0.001 μm to 2 μm , preferably from 0.001 μm to 0.2 μm , and more preferably from 0.001 25 μm to 0.1 μm . If the number average particle diameter is more than 2 μm , transparency of the cured product and surface conditions of the coating tend to be impaired. Moreover, various surfactants and amines may be added to improve dispersibility of particles.

30 Among silicon oxide particles, given as examples of commercially available products of silica particles are colloidal silica available under the

trade names Methanol Silica Sol, IPA-ST, MEK-ST, NBA-ST, XBA-ST, DMAC-ST, ST-UP, ST-OUP, ST-20, ST-40, ST-C, ST-N, ST-O, ST-50, ST-OL, etc., manufactured by Nissan Chemical Industries, Ltd. As powdery silica, products
5 available under the trade names AEROSIL 130, AEROSIL 300, AEROSIL 380, AEROSIL TT600, and AEROSIL OX50 (manufactured by Japan Aerosil Co., Ltd.), Sildex H31, H32, H51, H52, H121, H122 (manufactured by Asahi Glass Co., Ltd.), E220A, E220 (manufactured by Nippon Silica
10 Industrial Co., Ltd.), SYLYSIA470 (manufactured by Fuji Silycia Chemical Co., Ltd.) and SG Flake (manufactured by Nippon Sheet Glass Co., Ltd.), and the like can be given.

Given as commercially available products of
15 aqueous dispersion products of alumina are Alumina Sol-100, -200, -520 (trade names, manufactured by Nissan Chemical Industries, Ltd.); as an isopropanol dispersion of alumina, AS-150I (trade name, manufactured by Sumitomo Osaka Cement Co., Ltd.); as a
20 toluene dispersion of alumina, AS-150T (trade name, manufactured by Sumitomo Osaka Cement Co., Ltd.); as an aqueous dispersion product of zinc antimonate powder, Celnox (trade name, manufactured by Nissan Chemical Industries, Ltd.); as powders and solvent dispersion
25 products of alumina, titanium oxide, tin oxide, indium oxide, zinc oxide, etc., Nano Tek, for example, (trade name, manufactured by CI Kasei Co., Ltd.); as an aqueous dispersion sol of antimony dope-tin oxide, SN-100D (trade name, manufactured by Ishihara Sangyo
30 Kaisha, Ltd.); as an ITO powder, a product manufactured by Mitsubishi Material Co., Ltd.; and as an aqueous dispersion of cerium oxide, Needral (trade name, manufactured by Taki Chemical Co., Ltd.).

The shape of oxide particles may be globular, hollow, porous, rod-like, plate-like, fibrous, or amorphous, with a globular shape being preferable. The specific surface area of oxide particles (determined by a BET method using nitrogen) is preferably in the range from 5 10 to 1000 m²/g, and more preferably 100 to 500 m²/g. These oxide particles can be used either in the form of a dry powder or a dispersion in water or an organic 10 solvent. For example, a dispersion liquid of fine particles of oxide known in the art as a solvent dispersion sol of these oxides can be used. Use of a solvent dispersion sol of oxide is particularly desirable in the application in which excellent 15 transparency of cured products is required.

(2) Organic compound

The organic compound used in the present invention is a compound having a polymerizable unsaturated group in the molecule, and preferably a 20 specific organic compound comprising the group shown by the above-mentioned formula (1), [-X-C(=Y)-NH-]. In addition, the organic compound preferably includes a group represented by [-O-C(=O)-NH-] and at least one of the groups represented by [-O-C(=S)-NH-] or [-S-C(=O)- 25 NH-]. It is preferable that such organic compounds have a silanol group or a group that forms a silanol group by hydrolysis in the molecule.

1. Polymerizable unsaturated group

There are no specific limitations to the 30 polymerizable unsaturated group contained in the organic compound. An acryloyl group, methacryloyl group, vinyl group, propenyl group, butadienyl group, styryl group, ethynyl group, cinnamoyl group, maleate

group, and acrylamide group, can be given as suitable examples.

This polymerizable unsaturated group is a structural unit to effect an addition polymerization by 5 active radicals.

2. The group shown by the above formula (1)

There are 6 types for the group [-X-C (=Y)-NH-] of the formula (1) contained in the specific organic compound, specifically, they are [-O-C(=O)-NH-], [-O-C(=S)-NH-], [-S-C(=O)-NH-], [-NH-C(=O)-NH-], [-NH-C(=S)-NH-], and [-S-C(=S)-NH-]. These groups may be used either individually or in combinations of two or more. Among these, the combined use of the group [-O-C(=O)-NH-] and either one of the groups [-O-C(=S)-NH-] 10 and [-S-C(=O)-NH-] is preferable from the viewpoint of 15 ensuring excellent heat stability.

The above-mentioned group [-X-C (=Y)-NH-] of the formula (1) is considered to generate a moderate cohesive force by a hydrogen bond among molecules, 20 which provides the cured product with characteristics such as superior mechanical strength, excellent adhesion properties to substrates, and good heat resistance.

3. Silanol group or a group that forms a silanol group 25 by hydrolysis

The organic compound is preferably a compound having a silanol group (hereinafter may be called "silanol group-containing compound") or a compound that forms a silanol group by hydrolysis 30 (hereinafter may be called "silanol group-forming compound"). As a silanol group-forming compound, a compound having an alkoxy group, aryloxy group, acetoxy group, amino group, halogen group, or the like on a

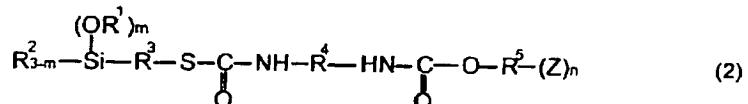
silicon atom can be given, with a compound including an alkoxy group or aryloxy group on a silicon atom, specifically, an alkoxy silyl group-containing compound or an aryloxy silyl group-containing compound being
5 preferable.

The silanol group or the silanol group-forming site of the silanol group-forming compound is the structural unit that bonds with the oxide particles by a condensation reaction or the condensation reaction
10 after hydrolysis.

4. Preferable embodiment

The compounds shown by the following formula (2) can be given as examples of preferable organic compounds,

15



wherein R¹ and R² individually represent a hydrogen atom or an alkyl group or aryl group having 1-8 carbon atoms
20 such as a methyl group, ethyl group, propyl group, butyl group, octyl group, phenyl group, xylyl group, and the like and wherein m is an integer of 1-3.

As examples of the group represented by [(R¹O)_mR²_{3-m}Si-], trimethoxysilyl group, triethoxysilyl group, triphenoxy silyl group, methyldimethoxysilyl group, dimethylmethoxysilyl group, and the like can be given. Of these groups, trimethoxysilyl group, triethoxysilyl group, and the like are desirable.

R³ is a divalent organic group having a C₁-C₁₂ aliphatic or aromatic structure that may include a linear, branched, or cyclic structure. A methylene,

ethylene, propylene, butylene, hexamethylene,
cyclohexylene, phenylene, xylylene, dodecamethylene,
and the like can be given as such organic groups. Of
these, preferable groups are methylene, propylene,
5 cyclohexylene, phenylene, and the like.

R⁴ is a divalent organic group and usually
selected from the divalent organic groups having a
molecular weight from 14 to 10,000, and preferably from
76 to 500. For example, a linear polyalkylene group
10 such as hexamethylene, octamethylene, and
dodecamethylene; an alicyclic or polycyclic divalent
organic group such as cyclohexylene and norbornylene; a
divalent aromatic group such as phenylene, naphthylene,
biphenylene, and polyphenylene; and an alkyl group or
15 aryl group substitution product of these groups can be
given. Moreover, these divalent organic groups may
include group having an element other than a carbon
atom and hydrogen atom, and may further include an
ether bond, ester bond, amide bond, carbonate bond, and
20 the group shown by the above-mentioned formula (1).

R⁵ is an organic group of a (n+1) valence
and preferably selected from the group consisting of
linear, branched, or cyclic, saturated or unsaturated
hydrocarbon groups.

25 Z is a monovalent organic group having a
polymerizable unsaturated group in the molecule that
causes an inter-molecular crosslinking reaction in the
presence of reactive radicals. For example, an
acryloyl(oxy) group, methacryloyl(oxy) group,
30 vinyl(oxy) group, propenyl(oxy) group, butadienyl(oxy)
group, styryl(oxy) group, ethynyl(oxy) group,
cinnamoyl(oxy) group, maleate group, acrylamide group,
methacrylamide group, and the like can be given. Among

these, an acryloyl(oxy) group and methacryloyl(oxy) group are desirable. Moreover, n is an integer preferably from 1 to 20, and more preferably from 1 to 10, and most preferably from 1 to 5.

5 The organic compound used in the present invention can be synthesized by a method described in Japanese Patent Application Laid-open No. 100111/1997, for example. Specifically, (a) a method comprising an addition reaction of a mercaptoalkoxysilane, a
10 polyisocyanate compound, and an active hydrogen group-containing polymerizable unsaturated compound can be used. Another method (b) comprises a direct reaction of a compound having both an alkoxy silyl group and an isocyanate group in the molecule with an active
15 hydrogen-containing polymerizable unsaturated compound. Still another method (c) comprises an addition reaction of a compound having both a polymerizable unsaturated group and an isocyanate group in the molecule with a mercapto alkoxysilane compound or aminosilane compound.

20 Among these methods, the method (a) is preferably used to synthesize the compound shown by the above-mentioned formula (2).

More specifically, for example, there is a method (a-1) which comprises causing
25 mercaptoalkoxysilane and a polyisocyanate compound to react to produce an intermediate compound having an alkoxy silyl group, a group [-S-C(=O)NH-], and an isocyanate group in the molecule, then causing a hydroxyl group-containing polymerizable unsaturated
30 compound to react with the isocyanate group which is present in the intermediate compound, thereby combining this unsaturated compound via the group [-S-C(=O)NH-]. Another method (a-2) comprises forming an intermediate

compound having a polymerizable unsaturated group, a group [-O-C(=O)-NH-] and an isocyanate group in the molecule by reacting a polyisocyanate compound and a hydroxyl group-containing polymerizable unsaturated 5 compound to, and then combining the mercaptoalkoxysilane via the group [-S-C(=O)-NH-] by reacting the intermediate compound with mercaptoalkoxysilane.

Among the two methods, the method (a-1) is 10 preferred because this method exhibits no decrease in the polymerizable unsaturated group due to the Michael addition reaction.

In the synthesis of the compound shown by the above-mentioned formula (2), a compound having at 15 least one alkoxy silyl group and at least one mercapto group in the molecule can be given as an example of the alkoxy silane which can form the group [-S-C(=O)-NH-] by the reaction with an isocyanate group. As such a mercaptoalkoxysilane, for example, 20 mercaptopropyltrimethoxysilane, mercaptopropyltriethoxysilane, mercaptopropylmethyldiethoxysilane, mercaptopropyldimethoxymethylsilane, mercaptopropylmethoxydimethylsilane, 25 mercaptopropyltriphenoxysilane, mercaptopropyltributoxysilane, and the like can be given.

Among these, mercaptopropyltrimethoxysilane and mercaptopropyltriethoxysilane are desirable. 30 Moreover, an addition compound of an amino-substituted alkoxy silane to an epoxy group-substituted mercaptan and an addition compound of α,ω -dimercapto compound to an epoxysilane can also be used.

The polyisocyanate compound used for synthesizing the organic compound can be selected from polyisocyanate compounds of a chain-like saturated hydrocarbon, cyclic saturated hydrocarbon, or aromatic hydrocarbons.

As examples of such a polyisocyanate compound,

2,4-tolylene diisocyanate, 2,6-tolylene diisocyanate,
1,3-xylylene diisocyanate, 1,4-xylylene diisocyanate,
10 1,5-naphthalene diisocyanate, m-phenylene diisocyanate,
p-phenylene diisocyanate, 3,3'-dimethyl-4,4'-
diphenylmethane diisocyanate, 4,4'-diphenylmethane
diisocyanate,
3,3'-dimethyl phenylene diisocyanate, 4,4'-biphenylene
15 diisocyanate, 1,6-hexane diisocyanate, isophorone
diisocyanate, methylenebis(4-cyclohexylisocyanate),
2,2,4-trimethylhexamethylene diisocyanate,
bis(2-isocyanatethyl)fumarate, 6-isopropyl-1,3-phenyl
diisocyanate, 4-diphenylpropane diisocyanate, lysine
20 diisocyanate, hydrogenated diphenylmethane
diisocyanate, 1,3-bis(isocyanatemethyl) cyclohexane,
tetramethyl xylylene diisocyanate, and 2,5 (or 6)-
bis(isocyanatemethyl)-bicyclo[2.2.1]heptane can be
given. Among these, 2,4-tolylene diisocyanate,
25 isophorone diisocyanate, xylylene diisocyanate,
methylenebis(4-cyclohexylisocyanate),
1,3-bis(isocyanatemethyl)cyclohexane, and the like are
desirable. These compounds may be used either
individually or in combination of two or more.

30 As examples of the active hydrogen-containing polymerizable unsaturated compound which can be bonded through the group [-O-C(=O)-NH-] by the addition reaction of the above-mentioned polyisocyanate

compound used in the synthesis of the organic compound, compounds having at least one active hydrogen atom which can form the group [-O-C(=O)-NH-] by the addition reaction with an isocyanate group and at least one 5 polymerizable unsaturated group in the molecule can be given.

Given as examples of such active hydrogen-containing polymerizable unsaturated compounds are 2-hydroxyethyl (meth)acrylate, 2-hydroxypropyl 10 (meth)acrylate, 2-hydroxybutyl (meth)acrylate, 2-hydroxy-3-phenyloxypropyl (meth)acrylate, 1,4-butanediol mono(meth)acrylate, 2-hydroxyalkyl (meth)acryloyl phosphate, 4-15 hydroxycyclohexyl (meth)acrylate, 1,6-hexanediol mono(meth)acrylate, neopentyl glycol mono(meth)acrylate, trimethylolpropane di(meth)acrylate, trimethylethane di(meth)acrylate, pentaerythritol tri(meth)acrylate, and 20 dipentaerythritol penta(meth)acrylate. In addition, compounds obtained by the addition reaction of a glycidyl group-containing compound such as alkyl glycidyl ether, allyl glycidyl ether, or glycidyl (meth)acrylate with (meth)acrylic acid can also be 25 used. Of these compounds, 2-hydroxyethyl (meth)acrylate, 2-hydroxypropyl (meth)acrylate, pentaerythritol tri(meth)acrylate, and the like are desirable.

These compounds may be used either 30 individually or in combinations of two or more.

(3) Preparation of crosslinkable particles (A)

Although there are no specific limitations to the method for preparing the crosslinkable particles

(A) used in the present invention, a method of reacting the organic compound and the oxide particles can be given as an example. The oxide particles are known to include moisture on the surface of particles as 5 adsorbed water under usual storage conditions. In addition, components which react with the silanol group-forming compound such as a hydroxide, hydrate, or the like are presumed to be present at least on the surface of the oxide particles. Therefore, the 10 crosslinkable particles (A) can be prepared by mixing the silanol group-forming compound and oxide particles, and heating the mixture while stirring. It is desirable that the reaction be carried out in the presence of water to efficiently bind the silanol 15 group-forming site possessed by the organic compound and the oxide particles. However, water may not be present when the organic compound possesses a silanol group. Therefore, the crosslinkable particles (A) is prepared by a method which includes at least the 20 operation of blending the oxide particles and the organic compound.

The amount of the organic compound bonded to the oxide particles is preferably 0.01 wt% or more, more preferably 0.1 wt% or more, and particularly 25 preferably 1 wt% or more, for 100 wt% of the crosslinkable particles (A) (the total of the oxide particles and the specific organic compound). If the amount of the organic compound bonded to the oxide particles is less than 0.01 wt%, the crosslinkable 30 particles (A) exhibit only inadequate dispersibility in the composition, which may result in cured products with insufficient transparency and scratch resistance. Moreover, the ratio of oxide particles in the raw

materials in the preparation of the crosslinkable particles (A) is preferably 5-99 wt%, and more preferably 10-98 wt%.

The method of preparing the crosslinkable particles (A) will now be described in more detail taking the alkoxy silyl group-containing compound (alkoxysilane compound) shown by the above formula (2) as an example of the silanol group-forming compound.

The amount of water consumed in the hydrolysis of the alkoxy silane compound in the preparation of the crosslinkable particles (A) may be the amount to hydrolyze at least one alkoxy group on the silicon atoms in the molecule. Preferably, the amount of water which is added or present during the hydrolysis reaction is one third (1/3) or more of the number of mols of the total alkoxy groups on the silicon atoms, with particularly preferable amount being from 1/2 to 3 times of the number of mols of the total alkoxy groups. The product obtained by blending the alkoxy silane compound and oxide particles under the condition where no water is present at all is a product in which the alkoxy silane compound is physically adsorbed on the surface of oxide particles. Only poor hardness and scratch resistance effect can be exhibited by the cured product obtained from the composition comprising such crosslinkable particles (A).

The methods which can be selected for the preparation of crosslinkable particles (A) include a method of separately hydrolyzing the above-mentioned alkoxy silane compound, and mixing the hydrolyzed product with a powder of oxide particles or a solvent dispersion sol of oxide particles with heating and stirring; a method of carrying out the hydrolysis of

the alkoxy silane compound in the presence of the oxide particles; and a method of treating the surface of the oxide particles in the presence of, for example, (D) the polymerization initiator and the like. Among 5 these, the method of hydrolyzing the alkoxy silane compound in the presence of oxide particles is desirable. The treatment for the preparation of the crosslinkable particles (A) is carried out at a temperature from 0°C to 150°C, and preferably from 20°C 10 to 100°C. The treating time is usually from 5 minutes to 24 hours.

When oxide particles in the form of a powder is used in the preparation of the crosslinkable particles (A), an organic solvent may be added to 15 ensure a smooth and homogeneous reaction with the alkoxy silane compound. The same solvents as used as the above-mentioned dispersion medium for the oxide particle sol can be used as such organic solvents. There are no specific limitations to the types of these 20 solvents, inasmuch as a smooth and homogeneous reaction is ensured.

When a solvent dispersion sol is used as the raw material for the crosslinkable particles (A), the crosslinkable particles (A) can be prepared by a 25 process comprising at least a step of mixing the solvent dispersion sol and the organic compound. Here, an organic solvent which is mutually soluble with water can be added to ensure homogeneity in the initial stage of the reaction and smooth reaction.

Moreover, an acid, salt, or base may be 30 added as a catalyst to accelerate the reaction to produce the crosslinkable particles (A). Given as examples of the acid are inorganic acids such as

hydrochloric acid, nitric acid, sulfuric acid, and phosphoric acid, organic acids such as methanesulfonic acid, toluenesulfonic acid, phthalic acid, malonic acid, formic acid, acetic acid, and oxalic acid, as well as unsaturated organic acids such as methacrylic acid, acrylic acid, and itaconic acid. As examples of the salt, ammonium salts such as tetramethylammonium chloride and tetrabutylammonium chloride can be given. Given as examples of the base, aqueous ammonia; primary, secondary, or tertiary aliphatic amines such as diethylamine, triethylamine, dibutylamine, and cyclohexylamine; aromatic amines such as pyridine; sodium hydroxide, potassium hydroxide; as well as quaternary ammonium hydroxides such as tetramethylammonium hydroxide, tetrabutylammonium hydroxide, and the like.

Among these, preferable catalysts are acids such as organic acids and unsaturated organic acids, and bases such as tertiary amines and quaternary ammonium hydroxide. The amount of these acids, salts, or bases to be added is preferably from 0.001 to 1.0 part by weight, and more preferably from 0.01 to 0.1 part by weight, for 100 parts by weight of the alkoxy silane compounds.

Preferably, a dehydrating agent is added to promote the reaction.

As a dehydrating agent, inorganic compounds such as zeolite, anhydrous silica, and anhydrous alumina, and organic compounds such as methyl orthoformate, ethyl orthoformate, tetraethoxymethane, and tetrabutoxymethane can be used. Of these, the organic compounds are preferred, with ortho esters such

as methyl orthoformate and ethyl orthoformate being particular preferred.

The amount of the alkoxy silane compound bonded with the crosslinkable particles (A) can be 5 determined as a weight loss (%) when a dry powder is burnt completely in air in a thermogravimetric analysis at a temperature from 110°C to 800°C.

The amount of crosslinkable particles (A) incorporated in the resin composition is from 5-90 wt%, 10 and preferably from 10-70 wt%, for 100 wt% of the composition (the total of the crosslinkable particles (A) and compound (C)). If less than 5 wt%, hardness of the cured products may be insufficient; if more than 90 wt%, there may be the occasion where coatings are not 15 cured and no coating films can be produced. The amount of the crosslinkable particles (A) here means the amount of the solid components and does not include the amount of solvents when the crosslinkable particles (A) are used in the form of a solvent dispersion sol.

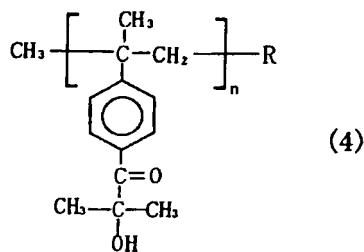
20 2. Oligomer-type radiation polymerization initiator

The oligomer-type radiation polymerization initiator (B) used in the present invention is a compound having a site which generates photo-radicals (active radicals) by irradiation of radioactive rays 25 and having a recurring unit which is a divalent organic group shown by the above formula (3). The oligomer-type radiation polymerization initiator (B) is used for improving balance between the hardness and low curling properties of the coatings made from the composition of 30 the present invention.

There are no specific limitations to the oligomer-type radiation polymerization initiator (B) inasmuch as the oligomer has a site which produces

photo-radicals by irradiation of radioactive rays. An example of preferably oligomers are those having a weight average molecular weight of 400 to 10,000. If less than 400, low curling properties may be 5 inadequate; if more than 10,000, the hardness may be insufficient.

Preferably the oligomer-type radiation polymerization initiator (B) is an oligo(2-hydroxy-2-methyl-1-(4-(1-methylvinyl)phenyl)propanone) of the 10 following formula (4),



wherein R is a mono-valent group, preferably an organic 15 mono-valent group, and n is an integer from 2 to 45.

A polymerization initiator (D) other than the oligomer-type radiation polymerization initiator (B) may be added to the composition of the present invention, as required.

As examples of the polymerization initiator (D) other than the oligomer-type radiation polymerization initiator (B), a compound generating active radicals (photo-radicals) by irradiation of radioactive rays (radiation polymerization initiator) 20 and a compound thermally generating active radicals (heat polymerization initiator) can be given.

There are no specific limitation to the radiation polymerization initiator other than the

oligomer-type radiation polymerization initiator (B) inasmuch as such an initiator can generate radicals by irradiation of light and initiate polymerization. Examples of such initiators include acetophenone,

5 acetophenone benzyl ketal, 1-hydroxycyclohexyl phenyl ketone, 2,2-dimethoxy-1,2-diphenylethan-1-one, xanthone, fluorenone, benzaldehyde, fluorene, anthraquinone, triphenylamine, carbazole, 3-methylacetophenone,

10 4-chlorobenzophenone, 4,4'-dimethoxybenzophenone, 4,4'-diaminobenzophenone, benzoin propyl ether, benzoin ethyl ether, benzyl dimethyl ketal, 1-(4-isopropylphenyl)-2-hydroxy-2-methylpropan-1-one, 2-hydroxy-2-methyl-1-phenylpropan-1-one, thioxanethone,

15 diethylthioxanthone, 2-isopropylthioxanthone, 2-chlorothioxanthone, 2-methyl-1-[4-(methylthio)phenyl]-2-morpholino-propan-1-one, 2-benzyl-2-dimethylamino-1-(4-morpholinophenyl)-butanone-1,4-(2-hydroxyethoxy)phenyl-(2-hydroxy-2-

20 propyl)ketone, 2,4,6-trimethylbenzoyl diphenylphosphine oxide, and bis-(2,6-dimethoxybenzoyl)-2,4,4-trimethylpentylphosphine oxide.

As examples of commercially available products of the photopolymerization initiator, Irgacure184, 369, 651, 500, 819, 907, 784, 2959, CGI1700, CGI1750, CGI1850, CG24-61, Darocur 1116, 1173 (manufactured by Ciba Specialty Chemicals Co., Ltd.), Lucirin TPO, LR8893 (manufactured by BASF), Ubecryl P36 (manufactured by UCB), and the like can be given.

A heat-polymerization initiator can be optionally added when curing the resin composition of the present invention. Peroxides and azo compounds can

be given as examples of preferable heat-polymerization initiators.

Specific examples include benzoyl peroxide, t-butyl peroxybenzoate, azobisisobutyronitrile, and the
5 like.

The amount of the oligomer-type radiation polymerization initiator (B) used in the composition of the present invention is from 0.01-20 parts by weight, and preferably from 0.1-10 parts by weight, for 100
10 parts by weight of the composition (the total of the crosslinkable particles (A) and the compound (B)). If less than 0.01 part by weight, curing may be inadequate; if more than 20 parts by weight, the hardness may be insufficient.

15 Both the oligomer-type radiation polymerization initiator (B) which is supplied as a single compound and supplied as a mixture with another photoinitiator or an acrylic monomer can be used.

Given as examples commercially available
20 products of the oligo(2-hydroxy-2-methyl-1-(4-(1-methylvinyl)phenyl)propanone shown by the above formula (3) are Ezacure KIP 150 (CAS-NO. 163702- 01-0, n=4 to 6), KIP65LT (a mixture of KIP 150 and tripropylene glycol diacrylate), KIP 100F (a mixture of KIP 150 and
25 2-hydroxy-2-methyl-1-phenylpropan-1-one), KT37, KT55 (both a mixture of KIP 150 and methyl benzophenone derivatives), KTO46 (a mixture of KIP 150, methyl benzophenone derivative, and 2,4,6-trimethylbenzoyl diphenylphosphine oxide), KIP75/B (a mixture of KIP 150
30 and 2,2-dimethoxy-1,2- diphenylethan-1-one), and the like.

3. Compound (C)

The compound (C) which is used in the

present invention is a compound having two or more polymerizable unsaturated groups in the molecule. The compound (C) is preferably used to increase film-forming capability of the composition. Although there
5 are no specific limitations to the types of compound (C) so long as the compound has two or more polymerizable unsaturated groups, (meth)acrylic esters and vinyl compounds can be given as examples. Of these, (meth)acrylic esters are preferred.

10 The following compounds can be given as specific examples of the compound (C) used in the present invention.

Given as examples of (meth)acrylic esters are trimethylolpropane tri(meth)acrylate,
15 ditrimethylolpropane tetra(meth)acrylate, pentaerythritol tri(meth)acrylate, pentaerythritol tetra(meth)acrylate, dipentaerythritol penta(meth)acrylate, dipentaerythritol hexa(meth)acrylate, glycerol tri(meth)acrylate, tris(2-hydroxyethyl) isocyanurate tri(meth)acrylate, ethylene glycol di(meth)acrylate, 1,3-butanediol di(meth)acrylate, 1,4-butanediol di(meth)acrylate, 1,6-hexanediol di(meth)acrylate, neopentyl glycol di(meth)acrylate, diethylene glycol di(meth)acrylate,
20 25 triethylene glycol di(meth)acrylate, dipropylene glycol di(meth)acrylate, and bis(2-hydroxyethyl) isocyanurate di(meth)acrylate; as well as ethylene oxide or propylene oxide addition poly(meth)acrylates to these (meth)acrylates, oligoester (meth)acrylates, oligoether (meth)acrylates, oligourethane (meth)acrylates, and
30 oligoepoxy (meth)acrylates having two or more (meth)acryloyl groups in the molecule, and the like. Among these, dipentaerythritol hexa(meth)acrylate,

dipentaerythritol penta(meth)acrylate, pentaerythritol tetra(meth)acrylate, and ditrimethylolpropane tetra(meth)acrylate are desirable.

- As vinyl compounds, divinylbenzene,
5 ethylene glycol divinyl ether, diethylene glycol divinyl ether, triethylene glycol divinyl ether, and the like can be given.

- Given as examples of commercially available products of the compound (C) are the products
10 commercially avail under the trade names Aronix M-400, M-408, M-450, M-305, M-309, M-310, M-315, M-320, M-350, M-360, M-208, M-210, M-215, M-220, M-225, M-233, M-240, M-245, M-260, M-270, M-1100, M-1200, M-1210, M-1310, M-1600, M-221, M-203, TO-924, TO-1270, TO-1231, TO-595,
15 TO-756, TO-1231, TO-1343, TO-902, TO-904, TO-905, and TO-1330 (manufactured by Toagosei Co., Ltd.); KAYARAD D-310, D-330, DPHA, DPCA-20, DPCA-30, DPCA-60, DPCA-120, DN-0075, DN-2475, SR-295, SR-355, SR-399E, SR-494, SR-9041, SR-368, SR-415, SR-444, SR-454, SR-492, SR-
20 499, SR-502, SR-9020, SR-9035, SR-111, SR-212, SR-213, SR-230, SR-259, SR-268, SR-272, SR-344, SR-349, SR-601, SR-602, SR-610, SR-9003, PET-30, T-1420, GPO-303, TC-120S, HDDA, NPGDA, TPGDA, PEG400DA, MANDA, HX-220, HX-620, R-551, R-712, R-167, R-526, R-551, R-712, R-604,
25 R-684, TMPTA, THE-330, TPA-320, TPA-330, KS-HDDA, KS-TPGDA, KS-TMPTA (manufactured by Nippon Kayaku Co., Ltd.); and Light Acrylate PE-4A, DPE-6A, DTMP-4A (manufactured by Kyoeisha Chemical Co., Ltd.); and the like.
30 The amount of the compound (C) used in the present invention is preferably from 10-95 wt%, and more preferably from 30-90 wt%, for 100 wt% of the composition (the total the crosslinkable particles (A)

and the compound (C)). If less than 10 wt%, hardness of the cured products is insufficient; if more than 95 wt%, a low curing properties in the cured products may be insufficient.

5 As required, a compound having one polymerizable unsaturated group in the molecule may be used in the composition of the present invention in addition to the compound (C).

4. Components other than the above components

10 Various components such as photosensitizers, and oxide particles other than the crosslinkable particles (A) can be incorporated in the composition of the present invention as required. Specific examples are given below.

15 (1) Photosensitizers

As photosensitizers, for example, triethylamine, diethylamine, N-methyldiethanoleamine, ethanolamine, 4-dimethylaminobenzoic acid, methyl 4-dimethylaminobenzoate, ethyl 4-dimethylaminobenzoate, 20 isoamyl 4-dimethylaminobenzoate, and the like can be given. As commercially available products of photosensitizers, KAYACURE DMBI, EPA (manufactured by Nippon Kayaku Co., Ltd.), and the like can be given.

(2) Oxide particles other than the crosslinkable
25 particles (A)

Oxide particles which are not bonded with an organic compound having a polymerizable unsaturated group, for example, can be given as oxide particles other than the crosslinkable particles (A).

30 (3) Various other additives

As additives, for example, antioxidants, UV absorbers, light stabilizers, silane coupling agents, aging preventives, thermal polymerization inhibitors,

coloring agents, leveling agents, surfactants, preservatives, plasticizers, lubricants, inorganic fillers, organic fillers, wettability improvers, coating surface improvers, and the like can be given.

- 5 As commercially available products of antioxidants, Irganox 1010, 1035, 1076, 1222 (manufactured by Ciba Specialty Chemicals Co., Ltd.), and the like can be given; as commercially available products of UV absorbers, Tinuvin P, 234, 320, 326,
- 10 327, 328, 213, 400 (manufactured by Ciba Specialty Chemicals Co., Ltd.), Sumisorb 110, 130, 140, 220, 250, 300, 320, 340, 350, 400 (manufactured by Sumitomo Chemical Industries Co., Ltd.), and the like can be given; as commercially available products of light
- 15 stabilizers, Tinuvin 292, 144, 622LD (manufactured by Ciba Specialty Chemicals Co., Ltd.), Sanol LS-770, 765, 292, 2626, 1114, 744 (manufactured by Sankyo Chemical Co.), and the like can be given; as examples of silane coupling agents, γ -aminopropyltriethoxysilane, γ -
- 20 mercaptopropyltrimethoxysilane, γ -methacryloxypropyltrimethoxysilane, and the like can be given; as commercially available products of these silane coupling agents, SH6062, SZ6030 (manufactured by Toray-Dow Corning Silicone Co., Ltd.), KBE903, KBM803
- 25 (manufactured by a Shin-Etsu Silicone Co., Ltd.), and the like can be given; and as commercially available products of aging preventives, Antigene W, S, P, 3C, 6C, RD-G, FR, AW (manufactured by Sumitomo Chemical Industries Co., Ltd.), and the like can be given.
- 30 (4) Additives other than above-mentioned additives

Given as additives other than those mentioned above are polymers, oligomers, and the like, for example, epoxy resins, polyamide, polyimide,

polyamideimide, polyurethane, polybutadiene, chloroprene, polyether, polyester, pentadiene derivatives, styrene/butadiene/styrene block copolymer, styrene/ethylene/butene/styrene block copolymer, 5 styrene/isoprene/styrene block copolymer, petroleum resins, xylene resin, ketone resin, fluorine-containing oligomer, silicon-containing oligomer, and polysulfide-type oligomer.

The composition of the present invention is 10 suitable as a coating material. Plastics (polycarbonate, polymethacrylate, polystyrene, polyester, polyolefin, epoxy, melamine, triacetyl cellulose, ABS, acrylonitrile-styrene resin, norbornene resin, etc.), metals, woods, papers, glass, slates, and 15 the like can be given as examples of the substrates to which the composition is coated. These substrates may be either in the shape of a film or a formed three-dimensional object. Conventional coating methods such as dipping, spray coating, flow coating, shower 20 coating, roll coating, brush coating, and the like can be given as coating methods. The thickness of coating films after cure and drying is usually from 0.1 to 400 μm , and preferably from 1 to 200 μm .

To adjust the coating film thickness, the 25 composition of the present invention can be used by diluting with a solvent. When used as a coating material, for example, the viscosity of the composition is usually from 0.1 to 50,000 $\text{mPa}\cdot\text{s}/25^\circ\text{C}$, and preferably from 0.5 to 10,000 $\text{mPa}\cdot\text{s}/25^\circ\text{C}$.

30 5. Method of curing the composition

The composition of the present invention is cured by heat and/or radioactive rays.

When the composition is cured by heat, an electric heater, infrared ray lamp, hot blast, and the like can be used as the heat source.

When radioactive rays are used, there are no specific limitations to the source of the radioactive rays so long as the composition can be cured in a short period of time after coating. As examples of the source of infrared rays, a lamp, resistance heating plate, laser, and the like can be given. As examples of the source of visible rays, sunlight, a lamp, fluorescent lamp, laser, and the like can be given. As the source of ultraviolet rays, a mercury lamp, halide lamp, laser, and the like can be given. As examples of the source of electron beams, a system of utilizing thermoelectrons produced by a commercially available tungsten filament, a cold cathode method generating electron beams by passing a high voltage pulse through a metal, and a secondary electron method which utilizes secondary electrons produced by collision of ionized gaseous molecules and a metal electrode can be given. As the source of α -rays, β -rays, and γ -rays, for example, fissionable materials such as Co^{60} and the like can be given. These radioactive rays can be used either individually or in combinations of two or more. In the latter case, the two or radioactive rays may be used either simultaneously or with a certain intervals.

II. Cured products

The cured products of the present invention can be obtained by applying the composition onto a plastic substrates, for example, and curing the coating. Specifically, such a cured product can be obtained as a coated form by applying the composition

onto an object, drying the coating by removing volatile components at a temperature preferably from 0 to 200°C, and curing the coating by heat and/or radioactive rays. Curing by heat is preferably performed under the 5 conditions from 20 to 150°C for 10 seconds to 24 hours. When the coating is cured by radioactive rays, use of ultraviolet rays and electron beams are preferable. Ultraviolet rays are irradiated at a dose preferably from 0.01-10 J/cm², and more preferably from 0.1 to 2 10 J/cm². Electron beams are irradiated under the conditions of 10-300 KV, an electron density of 0.02-0.30 mA/cm², and at a dose from 1-10 Mrad.

Because the cured products of the present invention possess excellent hardness, superior scratch 15 resistance, low curling properties, and superb adhesion, particularly well balanced hardness and low curling properties, the products are suitable for use as a protective coating material to prevent stains or scratches on plastic optical parts, touch panels, film-20 type liquid crystal elements, plastic containers, or flooring materials, wall materials, and artificial marbles which are used for architectural interior finish; as an adhesive for various substrates, a sealing material, and a vehicle for printing ink; and 25 the like.

Examples

The present invention will be explained in 30 more detail by examples, which are not intended to be limiting of the present invention. In the description below, "parts" and "%" respectively mean "parts by weight" and "wt%", unless otherwise indicated.

The words "solid content" in the present invention means the content of components excluding volatile components such as solvents from the composition in the present invention, specifically,

5 "solid content" means the content of a residue (nonvolatile components) obtained by drying the composition for one hour on a hot plate at 120°C.

Synthesis of organic compounds

10 Synthetic Example 1

20.6 parts of isophorone diisocyanate was added to a solution of 7.8 parts of mercaptopropyltrimethoxysilane and 0.2 part of dibutyl tin dilaurate in dry air in one hour while stirring at 15 50°C. The mixture was stirred for a further three hours at 60°C. After the addition of 71.4 parts of pentaerythritol triacrylate dropwise in one hour at 30°C, the mixture was stirred for a further three hours at 60°C with heating to obtain an organic compound (S1).

20 An infrared absorption spectrum of the product showed that the absorption peaks at 2550 cm⁻¹ characteristic to a mercapto group and at 2260 cm⁻¹ characteristic to an isocyanate group in the raw material have disappeared, and the absorption peaks at 1660 cm⁻¹ characteristic to 25 [-O-C(=O)-NH-] group and [-S-C(=O)-NH-] group and at 1720 cm⁻¹ characteristic to an acryloyl group have emerged, indicating production of an organic compound (specific organic compound) having an acryloyl group, [-O-C(=O)-NH-] group, and [-S-C(=O)-NH-] group as 30 polymerizable unsaturated groups.

Synthetic Example 2

38.7 parts of 1,3-bis(isocyanatemethyl)cyclohexane was added to a solution of 38.4 parts of 5 mercaptopropyltrimethoxysilane and 0.2 part of dibutyl tin dilaurate in dry air in one hour while stirring at 50°C. The mixture was stirred for a further three hours at 70°C. After the addition of 22.7 parts of 2-hydroxyethyl acrylate dropwise in one hour at 30°C, the 10 mixture was stirred for a further ten hours at 60°C with heating to obtain an organic compound (S2). The amount of isocyanate remaining in the product was analyzed to find that the remaining amount was 0.1% or less, indicating that the reaction was completed almost 15 quantitatively.

Preparation of crosslinkable particles (A)

Examples for preparing crosslinkable particles (A) are shown in Preparation Examples 1 to 4. 20 The results are summarized in Table 1.

Preparation Example 1

A mixture of 8.7 parts of the organic compound (S1) synthesized in Synthetic Example 1, 91.3 25 parts of methyl ethyl ketone silica sol (MEK-ST, manufactured by Nissan Chemical Industries, Ltd., the number average particle diameter: 0.022 µm, silica concentration: 30%), 0.2 part of iso-propanol, and 0.1 part of ion exchange water was stirred at 80°C for 3 30 hours in a dried air stream, followed by the addition of 1.4 parts of methyl orthoformate. The mixture was stirred for a further one hour while heating at the same temperature, to obtain a colorless transparent

dispersion liquid of crosslinkable particles (A) (Dispersion Liquid "a"). 2 g of the Dispersion Liquid "a" was weighed on an aluminum dish and dried for one hour on a hot plate at 120°C. The dried material was 5 weighed to indicate that the solid content was 35%.

Preparation Example 2

A mixture of 8.3 parts of the organic compound (S2) synthesized in Synthetic Example 2, 91.7 10 parts of methyl ethyl ketone silica sol (MEK-ST), and 0.8 part of ion exchanged water was stirred at 80°C for 3 hours in a dried air stream, followed by the addition of 4.9 parts of methyl orthoformate. The mixture was stirred for a further one hour while heating at the 15 same temperature (80°C) to obtain a semitransparent dispersion liquid of crosslinkable particles (A) (Dispersion Liquid "b"). The solid content of the Dispersion Liquid "b" was measured in the same manner as in Preparation Example 1 to indicate that the solid 20 content was 34%.

Preparation Example 3

A mixture of 4.8 parts of the organic compound (S1) synthesized in Synthesis Example 1, 95.2 25 parts of isopropanol alumina sol (trade name: AS-150I, the number average particle diameter: 0.013 µm, alumina concentration: 1 5%, manufactured by Sumitomo Osaka Cement Co., Ltd.), 0.01 part of p-methoxyphenol, and 1.0 part of ion-exchanged water was stirred for 3 hours 30 at 60°C. After the addition of 1.0 part of methyl orthoformate, the mixture was stirred for a further one hour to obtain a dispersion liquid of crosslinkable particles (A) (Dispersion Liquid "c"). The solid

content of the Dispersion Liquid "c" was measured in the same manner as in Preparation Example 1 to indicate that the solid content was 19%.

5 Preparation Example 4

A mixture of 8.2 parts of the organic compound (S1) prepared in Synthetic Example 1, 91.8 parts of toluene zirconium oxide sol (the number average particle diameter: 0.01 μm , zirconium oxide concentration: 30%), and 0.1 part of ion exchanged water was stirred at 60°C for 3 hours, followed by the addition of 1.3 parts of methyl orthoformate and 41.2 parts methyl ethyl ketone. The mixture was stirred for a further one hour while heating at the same temperature to obtain a dispersion liquid of crosslinkable particles (A) (Dispersion Liquid "d"). The solid content of the Dispersion Liquid "d" was measured in the same manner as in Preparation Example 1 to indicate that the solid content was 25%.

Table 1

	Preparation Example			
	1	2	3	4
Dispersion Liquid of crosslinkable particles (A)	a	b	c	d
Organic compound S1	8.7		4.8	8.2
S2		8.3		
Oxide particle sol P1	91.3	91.7		
P2			95.2	
P3				91.8
Ion-exchanged water	0.1	0.8	0.1	0.1
Isopropanol	0.2			
Methyl ethyl ketone				41.2
Methyl orthoformate	1.4	4.9	1.0	1.3
p-Methoxyphenol			0.01	
Solid components (%)	35	34	19	25
Oxide particles in raw materials (%)	76	77	72	77

P1: Methyl ethyl ketone silica sol (Oxide particle concentration: 30%)

5 P2: Isopropanol alumina sol (Oxide particle concentration: 15%)

P3: Toluene zirconium oxide sol (Oxide particle concentration: 30%)

10 Examples for the preparation of compositions

Examples for the preparation of the composition of the present invention are shown in Examples 1-4 and Comparative Examples 1-3. The weight ratio of the components for the compositions are shown

15 in Table 2.

Example 1

151 parts of Dispersion Liquid "a" prepared in the Preparation Example 1 (the crosslinkable 20 particles: 53 parts, dispersion medium: methyl ethyl ketone (MEK)), 23.5 parts of dipentaerythritol hexacrylate, and 23.5 parts of pentaerythritol

tetracrylate were mixed in a 500 cc eggplant flask. The mixture was concentrated using a rotary evaporator under reduced pressure to a volume of 131 parts. 122 parts of methyl isobutyl ketone (MIBK) and 4 parts of 5 oligo(2-hydroxy-2-methyl-1-(4-(1-methylvinyl)phenyl)propanone) were added, and the mixture was stirred for two hours at 50°C to obtain a composition in the form of a homogeneous solution. The preparation was carried out in a room shielded from 10 ultraviolet rays. The solid content of the composition was determined in the same manner as in Preparation Example 1, to find that the solid content was 40%.

Example 2

15 151 parts of the dispersion liquid of Dispersion Liquid "b" prepared in the Preparation Example 2 (the crosslinkable particles: 53 parts, dispersion medium: methyl ethyl ketone (MEK)), 23.5 parts of dipentaerythritol hexacrylate, 23.5 parts of 20 pentaerythritol hexacrylate, 55 parts of cyclohexanone, 4.5 parts of oligo(2-hydroxy-2-methyl-1-(4-(1-methylvinyl)phenyl)propanone) were blended by stirring for two hours in a dry air stream in a container shielded from ultraviolet rays at 50°C, to obtain a 25 composition in the form of a homogeneous solution. The solid content of the composition was determined in the same manner as in Preparation Example 1, to find that the solid content was 40%.

30 Examples 3 and 4

Compositions of Examples 3 and 4 were prepared in the same manner as in Example 2, except for using the components shown in Table 2.

Comparative Examples 1 and 2

Compositions of Comparative Examples 1 and 2 were prepared in the same manner as in Example 1 except for using the components shown in Table 2.

5

Comparative Example 3

Compositions of Comparative Example 3 was prepared in the same manner as in Example 2 except for using the components shown in Table 2.

10

Table 2

	Example			Comparative Example		
	1	2	3	4	1	2
Crosslinkable particles (A)						
Particles in Dispersion Liquid a	53					
Particles in Dispersion Liquid b		53			53	
Particles in Dispersion Liquid c			53			53
Particles in Dispersion Liquid d				78		
Compound with polymerizable unsaturated groups (C)						
M1	23.5	23.5	23.5	13	23.5	23.5
M2	23.5	23.5	23.5	9	23.5	23.5
Oligomer-type radiation polymerization initiator (B)	KIP150					47.0
Radiation polymerization initiator (D)						
R1	4.0	4.5	7.5	4.5		
R2			1.0			
R3					0.9	0.9
Organic solvent					0.9	0.9
MEK	31	103	18	91		
Toluene				143		
MIBK	122				31	98
Isopropanol			226		122	
Cyclohexanone		55	62			
Total	257.0	262.0	414.5	338.5	257.0	254.8
Nonvolatile components (%)	40	40	26	31	40	40
Properties of cured product						
Pencil hardness	8H	8H	8H	8H	8H	8H
Adhesion (%)	100	100	100	100	100	100
SW scratch resistance	Excellent	Excellent	Excellent	Excellent	Excellent	Excellent
Curling (mm)	10	10	15	9	35	40

Notes for Table 1

- M1: Dipentaerythritol hexacrylate
M2: Pentaerythritol hexacrylate
KIP150: Oligo(2-hydroxy-2-methyl-1-(4-(1-
5 methylvinyl)-phenyl)propanone)
R1: 1-Hydroxycyclohexyl phenyl ketone
R2: 2-Methyl-1-[4-(methylthio)phenyl]-2-
morpholino-propanone-1
R3: 2-Hydroxy-2-methyl-1-(1-phenyl)-propan-1-one
10

Evaluation of cured products

To demonstrate the effects of the composition of the present invention, the cured products obtained from the above-mentioned compositions by coating, drying, and exposure to radiation were evaluated. The evaluation methods used were as follows. The results of the evaluation are shown in Table 2.

1. Coating, drying, and curing conditions

In Examples 1-4 and Comparative Examples 1-20 3 in Table 2, the compositions were applied to substrates using a bar coater so as to produce dry films with a thickness of 10 µm, dried in a hot blast oven at 80°C for 3 minutes, irradiated at a dose of 1 J/cm² using a conveyer-type mercury lamp, and stored at 25 25°C for 24 hours before the evaluation.

2. Substrates

Glass plates were used for the pencil hardness test, polyethylene terephthalate (PET) films with a thickness of 188 µm were used for the steel wool 30 scratch resistance test and the evaluation of adhesion, and PET films with a thickness of 100 µm were used for the evaluation of curling properties.

3. Evaluation method

* Pencil hardness:

Cured coatings on the glass substrates were evaluated according to JIS K5400.

5 * Adhesion (%):

The number of remaining 1 mm x 1 mm squares among 100 squares in the cellophane tape cross-cut peeling test according to JIS K5400 was counted to evaluate the adhesion.

10 * Steel wool (SW) scratch resistance:

The Gakushin-type abrasion tester manufactured by Tester Industry Co., Ltd. was reciprocated 30 times using #0000 steel wool with a load of 500 g to evaluated scratch conditions of the 15 coating film surface by naked eye observation. The case where no scratch was found was rated as "Excellent", where there were 1-10 scratches was rated as "Good", and where more than 10 scratches was found was rated as "Bad".

20 * Curling property test:

A coating was prepared on a PET film with a thickness of 100 µm using the composition of the present invention, immediately followed by cutting of 10 cm x 10 cm strips with a cutter knife. The strips 25 were left at 25°C and RH 50% for 24 hours to measure the warping mean value (mm) from the four corners.

Effect of the Invention

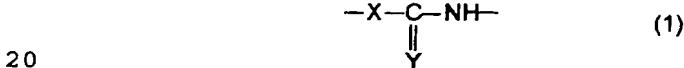
As described above, the present invention 30 provides a resin composition exhibiting excellent coatability and capable of forming coatings with high hardness, superior scratch resistance, low curling properties, and superb adhesion, particularly well

- 40 -

balanced high hardness and low curling properties, on the surface of various substrates, as well as the cured products made from the resin composition.

CLAIMS

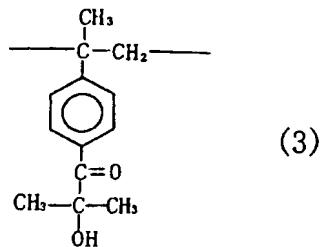
1. A resin composition comprising:
 - (A) particles prepared by bonding at least one oxide of an element selected from the group consisting of silicon, aluminum, zirconium, titanium, zinc, germanium, indium, tin, antimony, and cerium, and an organic compound which includes a polymerizable unsaturated group,
 - (B) an oligomer-type radiation polymerization initiator having a site which generates photo-radicals by irradiation of radioactive rays, and
 - (C) a compound having at least two polymerizable unsaturated groups in the molecule.
- 15 2. The resin composition according to claim 1, wherein said organic compound includes the group shown by the following formula (1) in addition to the polymerizable unsaturated group,



wherein X represents NH, O (oxygen atom), or S (sulfur atom), and Y represents O or S.

3. The resin composition according to claim 1 or 2, wherein the organic compound includes a group represented by $[-O-C(=O)-NH-]$ and at least one of the groups represented by $[-O-C(=S)-NH-]$ or $[-S-C(=O)-NH-]$.
4. The resin composition according to any one of claims 1-3, wherein the organic compound is a compound having a silanol group or a compound which forms a silanol group by hydrolysis.

5. The resin composition according to any one of claims 1-4, wherein the weight average molecular weight of the oligomer-type radiation polymerization initiator is in the range from 400
5 to 10,000.
6. The resin composition according to any one of claims 1-5, wherein the recurring unit in the oligomer-type radiation polymerization initiator (B) is a divalent organic group shown by the
10 following formula (3).



7. Use of the resin composition as defined in any of
15 claims 1-6 for producing cured products.
8. A cured product produced by curing the resin composition according to any one of claims 1 to 6.

INTERNATIONAL SEARCH REPORT

b International Application No
PCT/NL 00/00537

A. CLASSIFICATION OF SUBJECT MATTER
IPC 7 C08F292/00 C08F2/44 C09C1/28

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
IPC 7 C08F C09C C08K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

WPI Data, EPO-Internal, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	WO 97 12942 A (JAPAN SYNTHETIC RUBBER CO LTD ;BABA ATSUSHI (JP); ERIYAMA YUICHI () 10 April 1997 (1997-04-10) page 25, line 2 - line 9 page 30, line 19 page 30, line 31 - line 32 page 31, line 1; claims 1,13,14 & JP 09 100111 A 15 April 1997 (1997-04-15) cited in the application ---	1-8
A	EP 0 433 727 A (TOSHIBA SILICON) 26 June 1991 (1991-06-26) claims 1,3 ---	1 -/-

Further documents are listed in the continuation of box C.

Patent family members are listed in annex.

* Special categories of cited documents :

- "A" document defining the general state of the art which is not considered to be of particular relevance
- "E" earlier document but published on or after the international filing date
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- "O" document referring to an oral disclosure, use, exhibition or other means
- "P" document published prior to the international filing date but later than the priority date claimed

- "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.
- "&" document member of the same patent family

Date of the actual completion of the international search

31 October 2000

Date of mailing of the international search report

07/11/2000

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INTERNATIONAL SEARCH REPORT

Int'l Application No
PCT/NL 00/00537

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT		
Category	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	PATENT ABSTRACTS OF JAPAN vol. 1997, no. 09, 30 September 1997 (1997-09-30) & JP 09 118838 A (KOEI CHEM CO LTD), 6 May 1997 (1997-05-06) abstract -----	1-8
A	PATENT ABSTRACTS OF JAPAN vol. 018, no. 632 (C-1280), 2 December 1994 (1994-12-02) & JP 06 240181 A (SEKISUI CHEM CO LTD), 30 August 1994 (1994-08-30) abstract -----	1-8

INTERNATIONAL SEARCH REPORT

Information on patent family members

International Application No
PCT/NL 00/00537

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JP 06240181	A 30-08-1994	NONE		